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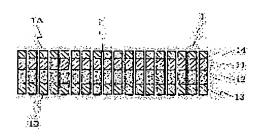
HIROTA KOICHI

(54) PRESSURE-SENSITIVE ADHESIVE SHEET AND ITS MANUFACTURING METHOD

(57)Abstract:

PROBLEM TO BE SOLVED: To provide a pressure–sensitive adhesive sheet which secures sufficient adhesive force without adversely affecting the external appearance of the pressure–sensitive adhesive sheet and can prevent or remove trapped air or a blister, and a method for manufacturing such a pressure–sensitive adhesive.

SOLUTION: In the laminated sheet obtained by laminating a decorative layer 14, a base material 11, a pressure–sensitive adhesive layer 12, and a releasing material 13, a plurality of penetrating holes 2 which penetrate from one side of the laminated sheet to the other side are formed. The hole diameter of the penetrating holes 2 is set to 0.1–300 μm and a hole density is set to 30–50,000/100 cm2. Such penetrating holes 2 are preferably formed by laser processing.



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